DATA SHEET : CKRF2409MM26

High Power SPDT Switch for WiMAX

Features

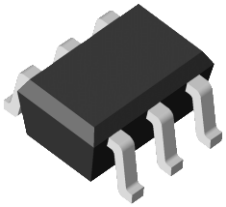
- Control voltage :
  VC(H) = 1.8 to 5.0 V (3.0V TYP.)
  VC(L) = -0.2 to 0.2 V (0V TYP.)
- Low insertion loss :
  L_{ins} = 0.35 dB TYP. @ f = 1.0 GHz
  L_{ins} = 0.42 dB TYP. @ f = 2.5 GHz
  L_{ins} = 0.45 dB TYP. @ f = 3.0 GHz
- High isolation :
  ISL = 34 dB TYP. @ f = 1.0 GHz
  ISL = 30 dB TYP. @ f = 2.5 GHz
  ISL = 26 dB TYP. @ f = 3.0 GHz
- Handling power :
  $P_{in(0.1dB)}$ = +36.5 dBm TYP. @ f = 0.4 to 3.8 GHz, VC(H) = 3.0 V, VC(L) = 0 V

Package

6-pin mini mold package
(2.0mm x 1.25mm x 0.9mm)

Description

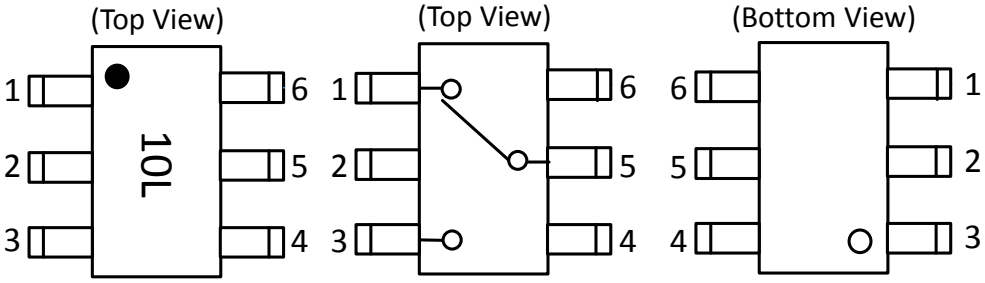
- The CKRF2409MM26 is a GaAs MMIC SPDT(Single Pole Double Throw) switch which was developed for WiMAX and wireless LAN



Applications

- WiMAX and wireless LAN
  (IEEE802.11 b/g), etc.

Pin Configuration and Internal Block Diagram



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	VC2
5	RFC
6	VC1

Ordering Information

Part Number	Order Number	Package	Marking	Supplying Form
CKRF2409MM26-C4	CKRF2409MM26-C4	6-pin mini mold package (Pb-Free)	10L	・Embossed tape 8 mm wide ・Pin 4, 5, 6 face the perforation side of the tape ・Qty 10 Kpcs/reel

Absolute Maximum Ratings

(T_A = +25℃, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Control Voltage	VC	6.0[Note 1]	V
Input Power	Pin	+38.0[Note 2]	dBm
Operating Ambient Temperature	T_A	-45～+85	℃
Storage Temperature	T_{stg}	-55～+150	℃

Note 1. |VC1 - VC2|≦6.0V

2. 3.0V≦|VC1 – VC2|≦5.0V, 0.4GHz≦f≦3.8GHz

Recommended Operating Range

(T_A = +25℃, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.05	-	3.8	GHz
Switch Control Voltage (H)	VC(H)	+1.8	+3.0	+5.0	V
Switch Control Voltage (L)	VC(L)	-0.2	0	+0.2	V

Truth Table

VC1	VC2	RFC-RF1	RFC-RF2
High	Low	ON	OFF
Low	High	OFF	ON

Electrical Characteristics

(T_A=+25℃, VC(H)=3.0V, VC(L)=0V, Zo=50Ω, DC Block Capacitance=8pF, unless otherwise specified)

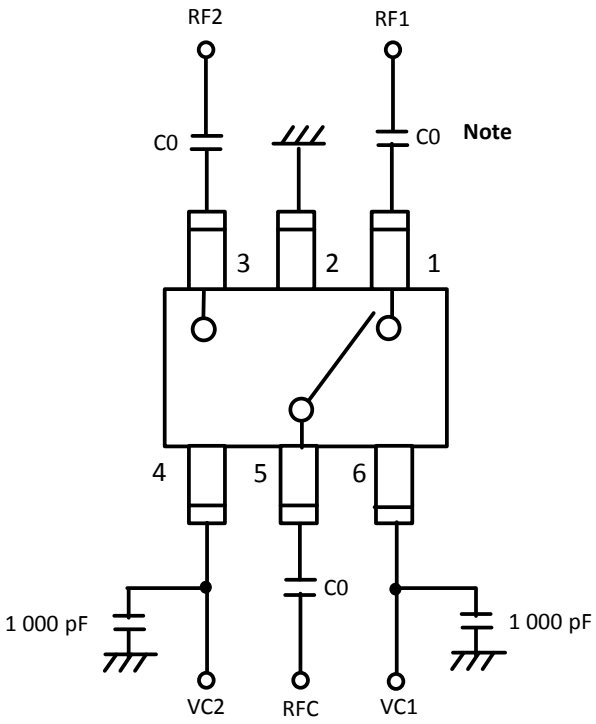
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins1	f = 0.05 to 0.5 GHz **Note 1**	-	0.35	0.55	dB
	Lins2	f = 0.5 to 1.0 GHz **Note 2**	-	0.35	0.55	dB
	Lins3	f = 1.0 to 2.0 GHz **Note 2**	-	0.40	0.60	dB
	Lins4	f = 2.0 to 2.5 GHz	-	0.42	0.62	dB
	Lins5	f = 2.5 to 3.0 GHz	-	0.45	0.70	dB
	Lins6	f = 3.0 to 3.8 GHz	-	0.50	0.80	dB
Isolation	ISL1	f = 0.05 to 0.5 GHz **Note 1**	32	35	-	dB
	ISL2	f = 0.5 to 1.0 GHz **Note 2**	31	34	-	dB
	ISL3	f = 1.0 to 2.0 GHz **Note 2**	29	32	-	dB
	ISL4	f = 2.0 to 2.5 GHz	27	30	-	dB
	ISL5	f = 2.5 to 3.0 GHz	23	26	-	dB
	ISL6	f = 3.0 to 3.8 GHz	18	21	-	dB
Return Loss	RL1	f = 0.05 to 0.5 GHz **Note 1**	15	20	-	dB
	RL2	f = 0.5 to 2.0 GHz **Note 2**	15	20	-	dB
	RL3	f = 2.0 to 3.8 GHz	15	20	-	dB
0.1 dB Loss Compression Input Power **Note 3**	$P_{in(0.1dB)}$	f = 0.4 to 3.8 GHz	-	+36.5	-	dBm
2nd Harmonics	2f0	f = 2.5 GHz, P_{in}=+26dBm	-	80	-	dBc
3rd Harmonics	3f0	f = 2.5 GHz, P_{in}=+26dBm	-	85	-	dBc
Input 3rd Order Intercept Point	IIP3	f = 2.5GHz 2-tone 1MHz Spacing	-	+62	-	dBm
Error Vector Magnitude	EVM	802.11g, 64QAM, 54Mbps, Pin≦+25dBm	-	0.5	-	%
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	100	-	ns
Switch Control Current	Icont	Non RF	-	7	-	μA

Note 1 DC block capacitance = 1,000pF at f=0.05 to 0.5 GHz

Note 2 DC block capacitance = 56pF at f=0.4 to 2.0 GHz

Note 3 $P_{in(0.1dB)}$ is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

Evaluation Circuit

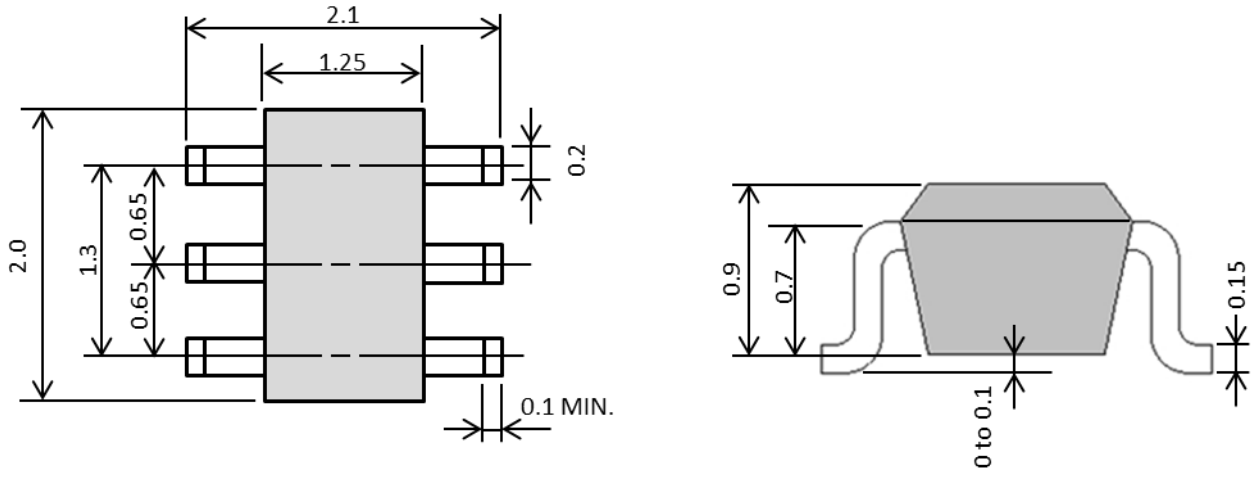


Note C0 : 0.05 to 0.5 GHz 1,000pF
: 0.4 to 2.0 GHz 56pF
: 2.0 to 3.8 GHz 8pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins. This device is used it is necessary to use DC Block Capacitance.

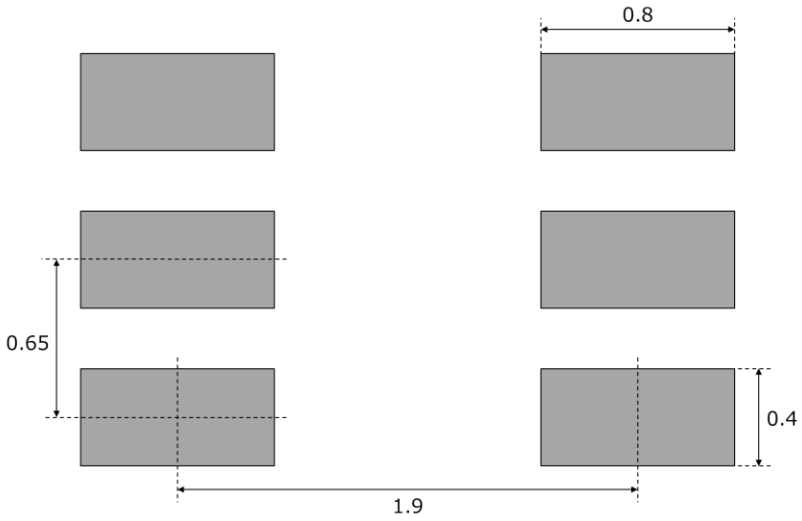
Package Dimensions

6-pin mini mold package (Unit : mm)



PCB Layout Footprint

6-pin mini mold (Unit : mm)



The PCB Layout Footprint in this document is for reference only.

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This product uses gallium arsenide (GaAs) of the toxic substance appointed in laws and ordinances. GaAs vapor and powder are hazardous to human health if inhaled or ingested.

- Do not dispose in fire or break up this product.
- Do not chemically make gas or powder with this product.
- When discard this product, please obey the law of your country.
- Do not lick the product or in any way allow it to enter the mouth.

[CAUTION]

Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

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